

#### **STAC2933**

# RF power transistor: HF/VHF/UHF N-channel MOSFETs

Preliminary data

#### **Features**

- Gold metallization
- Excellent thermal stability
- Common source configuration
- P<sub>OUT</sub>=300 W min. with 20 dB gain @ 30 MHz
- STAC air cavity packaging technology -STAC<sup>®</sup> package

#### **Description**

The STAC2933 is a gold metallized N-channel MOS field-effect RF power transistor, intended for use in 50 V dc large signal applications up 150 MHz. Its special low thermal-resistance package makes it ideal for ISM applications where reliability and ruggedness are critical factors.

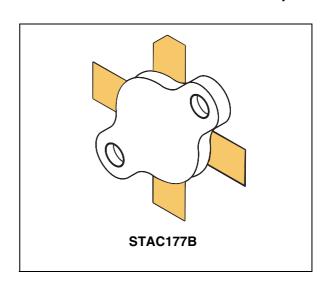


Figure 1. Pin connection

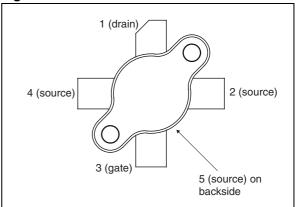


Table 1. Device summary

Order code	Marking	Base qty.	Package	Packaging <sup>(1)</sup>
STAC2933	STAC2933 <sup>(1)</sup>	25 pcs	STAC177B	Plastic tray

<sup>1.</sup> For more details please refer to Chapter 6: Marking, packing and shipping specifications..

Content STAC2933

### Content

1	Electrical data	3
	1.1 Maximum rating	
	1.2 Thermal data	3
2	Electrical characteristics	4
3	Impedance	6
4	Typical performance	7
5	Package mechanical data	8
6	Marking, packing and shipping specifications	0
7	Revision history	1

STAC2933 Electrical data

#### 1 Electrical data

#### 1.1 Maximum rating

 $T_{CASE} = 25^{\circ} C$ 

Table 2. Absolute maximum rating

Symbol	Parameter	Value	Unit
V <sub>(BR)DSS</sub>	Drain source voltage	130	V
V <sub>DGR</sub>	Drain-gate voltage ( $R_{GS} = 1M\Omega$ )	130	V
$V_{GS}$	Gate-Source voltage	± 20	V
I <sub>D</sub>	Drain current	40	Α
P <sub>DISS</sub>	Power dissipation	795	W
Tj	Max. operating junction temperature	200	°C
T <sub>STG</sub>	Storage temperature	-65 to +150	°C

#### 1.2 Thermal data

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction -case thermal resistance	0.22	°C/W

Electrical characteristics STAC2933

### 2 Electrical characteristics

 $T_{CASE} = 25^{\circ}C$ 

Table 4. Static

Symbol		Test conditions				Max.	Unit
V <sub>(BR)DSS</sub>	$V_{GS} = 0 V$	I <sub>DS</sub> = 200 mA		130			V
I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 50 \text{ V}$				100	μΑ
I <sub>GSS</sub>	V <sub>GS</sub> = 20 V	$V_{DS} = 0 V$				500	nA
V <sub>GS(Q)</sub> <sup>(1)</sup>	V <sub>DS</sub> = 10 V	$I_{D} = 250 \text{ mA}$		see	table be	elow	V
V <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A				3	V
G <sub>FS</sub> <sup>(1)</sup>	V <sub>DS</sub> = 10 V	I <sub>D</sub> = 10 A		see	table be	elow	mho
C <sub>ISS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 50 V	f = 1 MHz		1000		pF
C <sub>OSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 50 V	f = 1 MHz		372		pF
C <sub>RSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 50 V	f = 1 MHz		29		pF

<sup>1.</sup>  $V_{GS}$  and  $G_{FS}$  sort for each unit.

Table 5. Dynamic

Symbol	Test conditions	Min.	Тур.	Max.	Unit
P <sub>OUT</sub>	$V_{DD} = 50 \text{ V}$ $I_{DQ} = 250 \text{ mA}$ $f = 30 \text{ MHz}$	300	400		W
G <sub>PS</sub>	$V_{DD} = 50 \text{ V}$ $I_{DQ} = 250 \text{ mA}$ $P_{OUT} = 300 \text{ W}$ $f = 30 \text{ MHz}$	20	23.5		dB
h <sub>D</sub>	$V_{DD} = 50 \text{ V}$ $I_{DQ} = 250 \text{ mA}$ $P_{OUT} = 300 \text{ W}$ $f = 30 \text{ MHz}$	50	65		%
Load Mismatch	$V_{DD} = 50 \text{ V}$ $I_{DQ} = 250 \text{ mA}$ $P_{OUT} = 300 \text{ W}$ $f = 30 \text{ MHz}$ All phase angles	3:1			VSWR

Table 6. G<sub>FS</sub> sort

G <sub>FS</sub> sort	Value	G <sub>FS</sub> sort	Value
Α	10 - 10.99	E	14 -14.99
В	11 - 11.99	F	15 - 15.99
С	12 - 12.99	G	16 - 16.99
D	13 - 13.99	Н	17 - 18

Table 7. V<sub>GS</sub> sort

V <sub>GS</sub> sort	Value
1	1.5 - 2.0
2	2.0 - 2.5
3	2.5 - 3.0
4	3.0 - 3.5
5	3.5 - 4.0

Impedance STAC2933

# 3 Impedance

Figure 2. Impedance data schematic

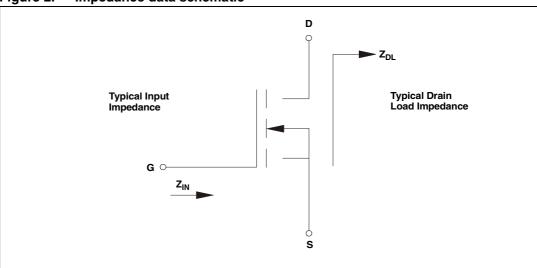


Table 8. Impedance data

FREQ	Z <sub>IN</sub> (Ω)	<b>Z</b> <sub>DL</sub> (Ω)
30 MHz	1.8 - j 0.2	2.8 + j 2.3
108 MHz	1.9 + j 0.2	1.6 + j 1.4
175 MHz	1.9 + j 0.3	1.5 + j 1.6

STAC2933 Typical performance

## 4 Typical performance

Figure 3. Capacitance vs drain voltage

Figure 4. Drain current vs gate voltage

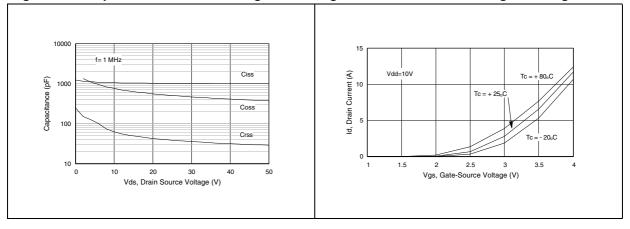
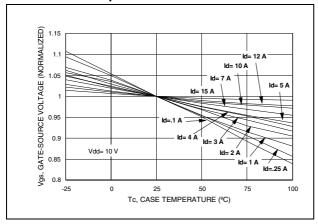


Figure 5. Gate-source voltage vs. case temperature



### 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 9. STAC177B mechanical data

Dim	mm				inch	
Dilli	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	5.72		5.97	0.225		0.235
В	6.73		6.99	0.265		0.275
С	21.84		22.10	0.860		0.870
D	28.70		28.96	1.130		1.140
E		28.02			1.103	
F	0.10		0.15	0.004		0.006
G		0.81			0.032	
Н	1.45		1.70	0.057		0.067
I	5.79		6.15	0.228		0.242
J	27.43		28.45	1.080		1.120
K	15.01		15.27	0.591		0.601

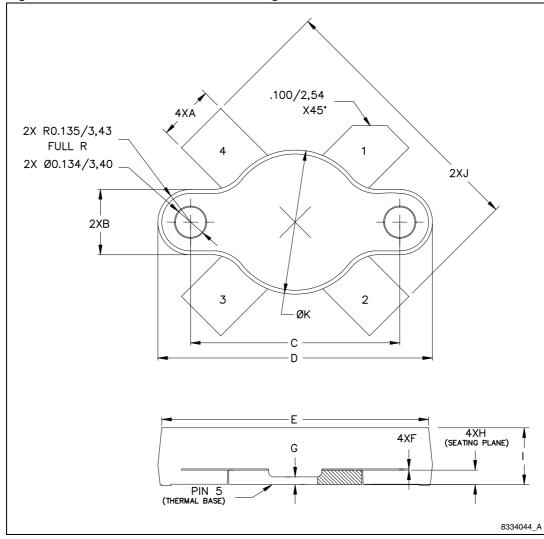


Figure 6. STAC177B mechanical drawing

## 6 Marking, packing and shipping specifications

Table 10. Packing and shipping specifications

Order code	Packaging	Pcs per tray	Dry pack humidity	V <sub>GS</sub> and GFS code	Lot code
STAC2933	Plastic tray	25	< 10 %	Not mixed	Not mixed

Figure 7. Marking layout

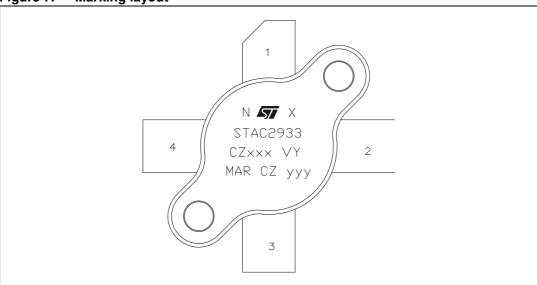


Table 11. Marking specifications

Symbol	Description
Х	G <sub>FS</sub> sort
N	V <sub>GS</sub> sort
CZ	Assembly plant
XXX	Last 3 digit of diffusion lot
VY	Diffusion plant
MAR	Country of origin
CZ	Test and finishing plant
у	Assembly year
уу	Assembly week

STAC2933 Revision history

# 7 Revision history

Table 12. Document revision history

Date	Revision	Changes
16-Jan-2012	1	Initial release.

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